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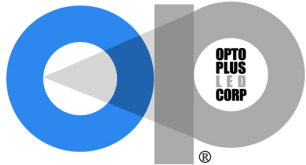
Opto Plus LED Corp
OPS-L0318PG
Side View Chip LED

● **EDIT HISTORY**

Version A : Jun. 20, 2022

Preliminary Spec.

Confidential Document



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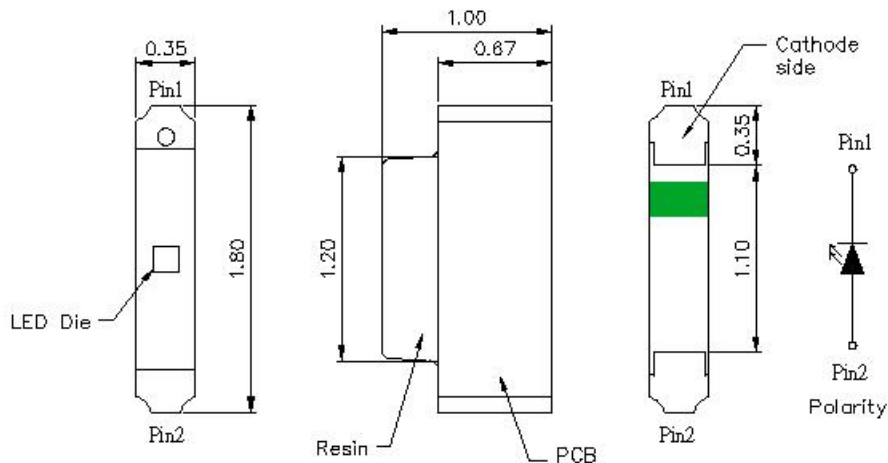
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Side View Chip LED

● FEATURES

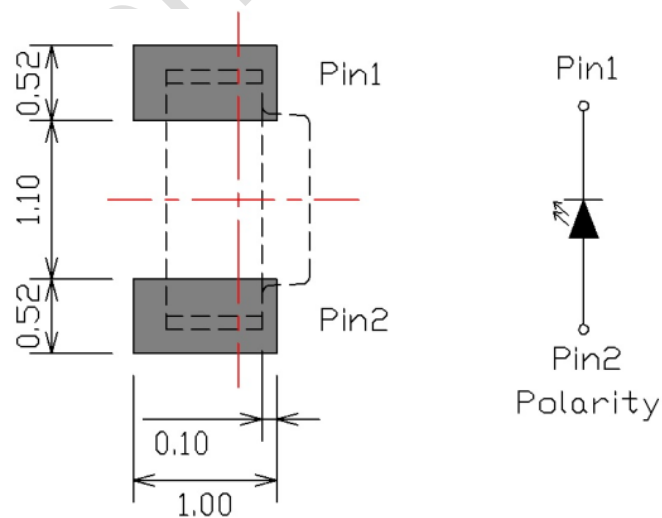
- 0.35 x 1.8 x 1.0 Side View Chip LED
- Wide viewing angle.
- Low power consumption.
- RoHS compliant.

● PACKAGE DIMENSIONS



Unit:mm Tolerance: +/-0.1

● SOLDERING PATTERN



Unit:mm Tolerance: +/-0.1

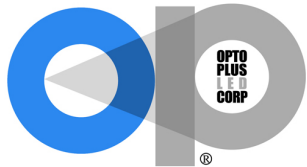
● **PG: PURE GREEN (InGaN/GaN)**

ABSOLUTE MAXIMUM RATING AT Ta=25°C

Parameter	Symbol	Maximum Rating	Unit
Power dissipation per SMD	P _{AD}	78	mW
Continuous forward current per SMD	I _{AF}	20	mA
Peak current per dice (duty cycle 1/10, 1kHz)	I _{PF}	80	mA
Reverse voltage per SMD	V _R	5	V
Operating temperature	T _{OPR}	-40 to +85	°C
Storage temperature	T _{STG}	-40 to +100	°C

ELECTRICAL - OPTICAL CHARACTERISTICS AT Ta=25°C

Characteristic	Symbol	Condition	Min.	Typ.	Max.	Unit
Forward voltage	V _F	I _F =20mA	-	3.3	3.9	V
Reverse current	I _R	V _R =5V	-	-	10	μA
Peak wavelength	λ _P	I _F =20mA	-	520	-	nm
Dominant wavelength	λ _D	I _F =20mA	-	525	-	nm
Luminous intensity	I _V	I _F =20mA	-	180	-	mcd
Spectral radiation bandwidth	Δλ	I _F =20mA	-	30	-	nm
Viewing Angle	2θ1/2	X	-	140	-	deg
		Y		120		



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● Luminous Intensity (Iv) Bin: (mcd)

Bin Code	R	S	T	-
Spec. Range	180.0~285.0	285.0~360.0	360.0~450.0	-

Note: It maintains a tolerance of $\pm 10\%$ on Luminous Intensity

● Wavelength Bin: (nm)

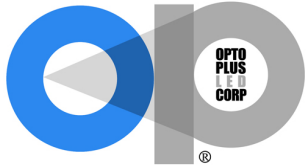
Bin Code	A	B	C	D
Spec. Range	515.0~520.0	520.0~525.0	525.0~530.0	530.0~535.0

Note: It maintains a tolerance of $\pm 0.5\text{nm}$ on Wavelength Bin

● Forward Voltage (Vf) Bin: (v)

Bin Code	G8	H7	H8	J7	J8	K7
Spec. Range	2.7~2.9 V	2.9~3.1 V	3.1~3.3 V	3.3~3.5 V	3.5~3.7 V	3.7~3.9 V

Note: It maintains a tolerance of $\pm 0.05\text{V}$ on forward voltage measurements



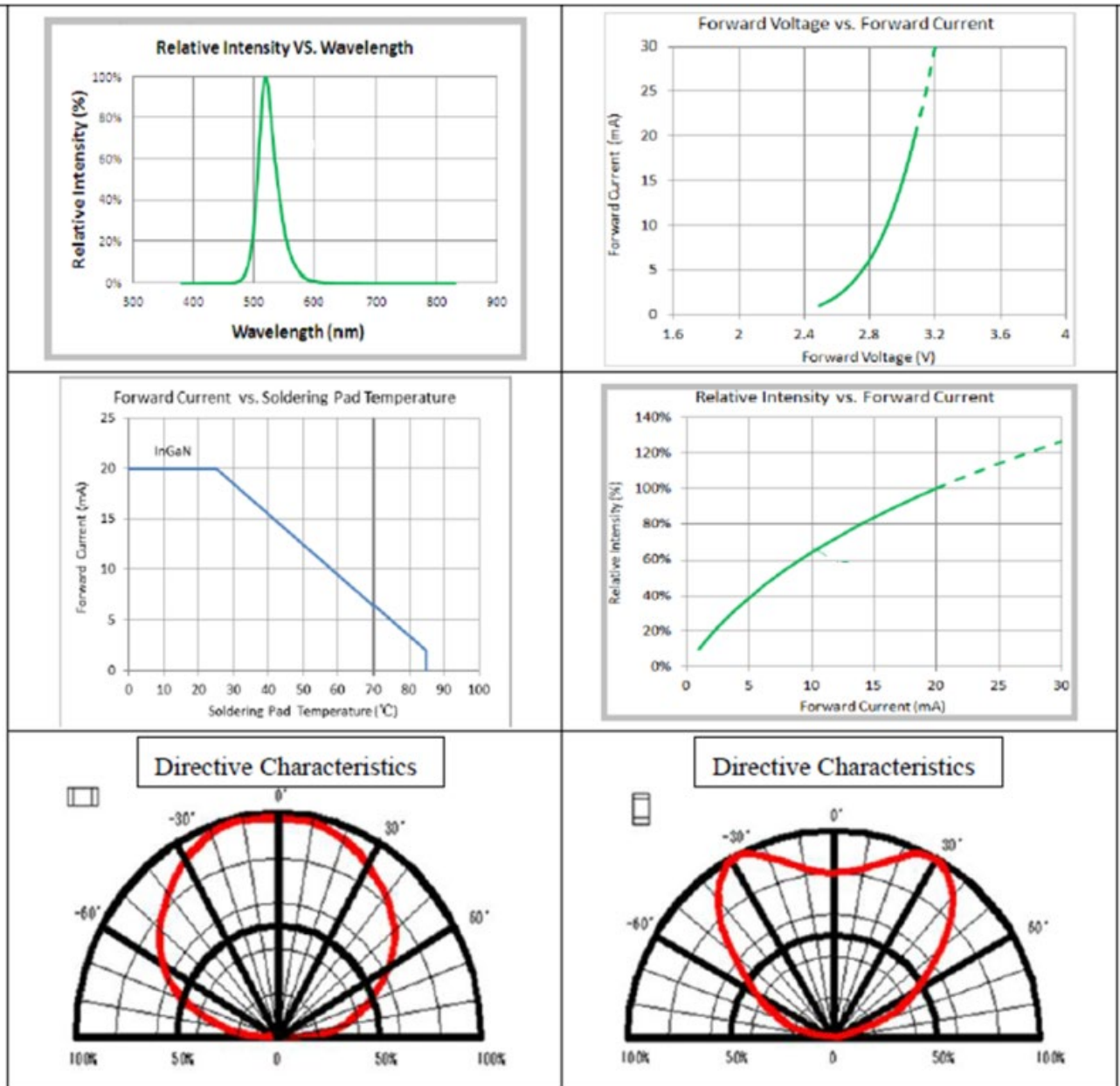
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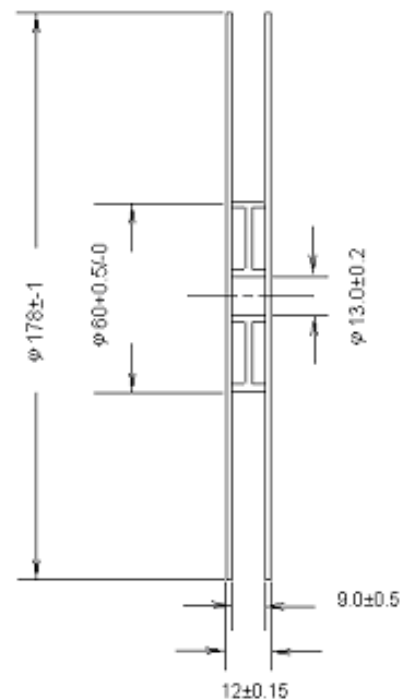
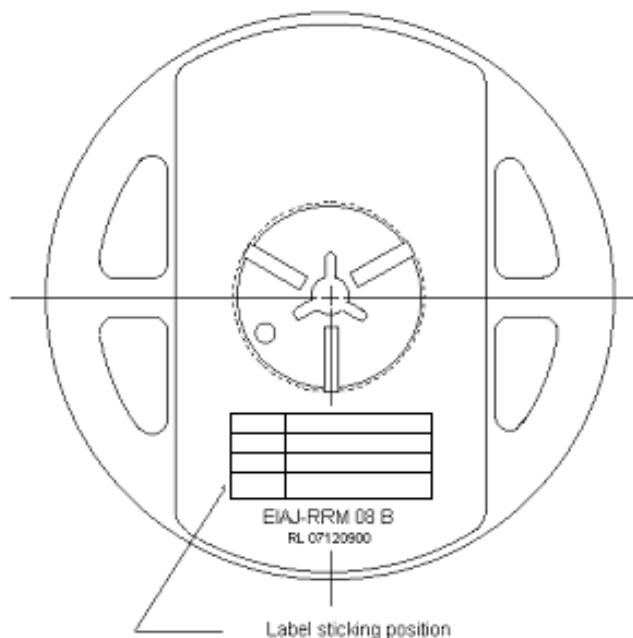
Typical Electro-optical Characteristic Curves
(25 °C Free Air Temperature Unless Otherwise Specified)

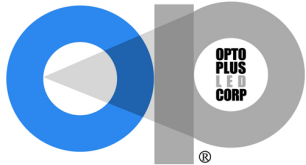


Precaution for Use

1. The chips should not be used directly in any type of fluid such as water, oil, organic solvent, etc.
2. When the LEDs are illuminating, the maximum ambient temperature should be first considered before operation.
3. LEDs must be stored in a clean environment. A sealed container with a nitrogen atmosphere is necessary if the storage period is over 3 months after shipping.
4. The LEDs must be used within 4 weeks after unpacked. Unused products must be repacked in an anti-electrostatic package, folded to close any opening and then stored in a dry and cool space.
5. The appearance and specifications of the products may be modified for improvement without further notice.
6. The LEDs are sensitive to the static electricity and surge. It is strongly recommended to use a grounded wrist band and anti-electrostatic glove when handling the LEDs. If a voltage over the absolute maximum rating is applied to LEDs, it will damage LEDs. Damaged LEDs will show some abnormal characteristics such as remarkable increase of leak current, lower turn-on voltage and getting unlit at low current.

Reel Dimension





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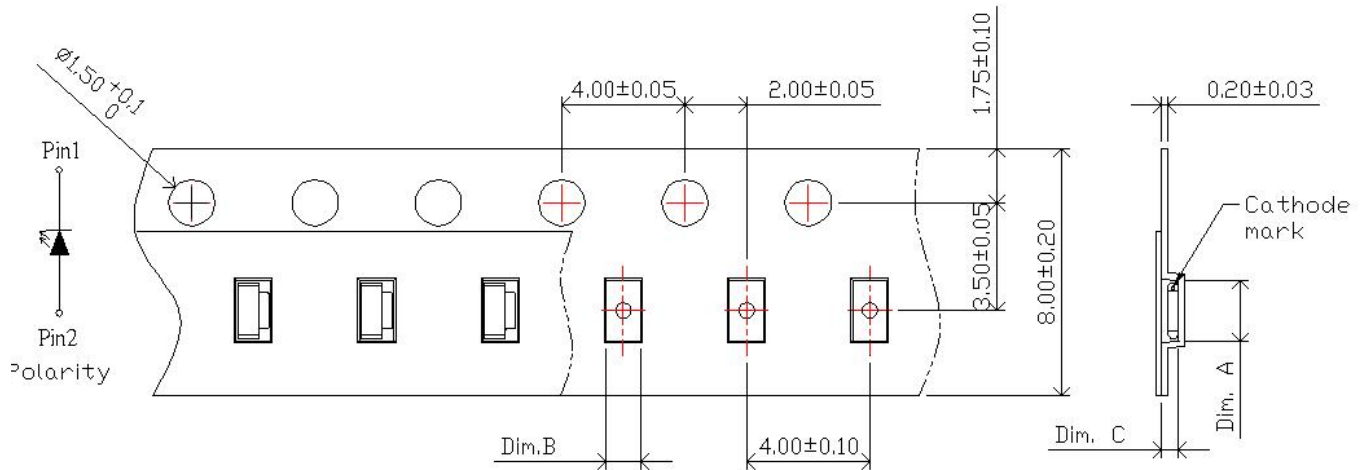
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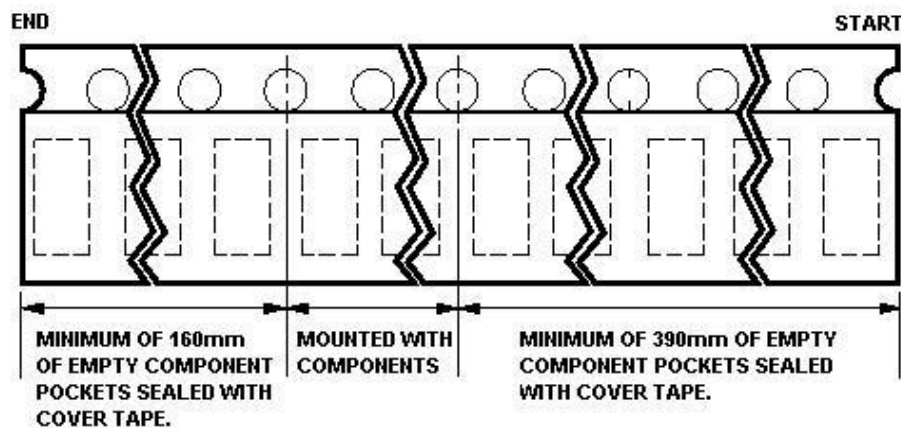
Packaging

Tape Dimension



Dim. A	Dim. B	Dim. C	Q'ty/Reel
1.97±0.05	1.12±0.05	0.55±0.05	4K

Unit: mm

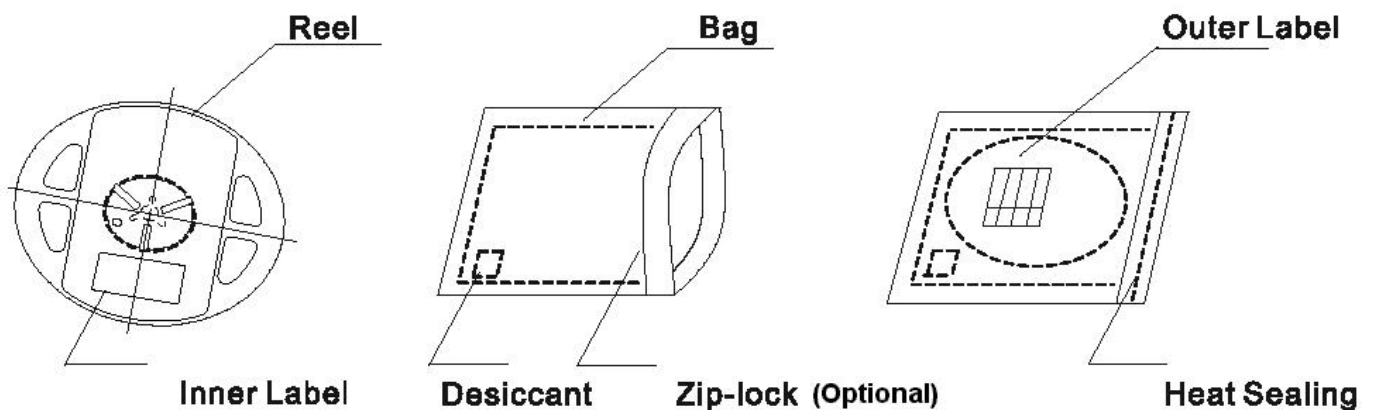


Dry Pack

All SMD optical devices are **MOISTURE SENSITIVE**. Avoid exposure to moisture at all times during transportation or storage. Every reel is packaged in a moisture protected anti-static bag. Each bag is properly sealed prior to shipment.

A humidity indicator will be included in the moisture protected anti-static bag prior to shipment.

The packaging sequence is as follows:



Baking

Baking before soldering is recommended when the package has been unsealed for 4 weeks.

The conditions are as followings:

1. $60 \pm 3^{\circ}\text{C} \times (12 \sim 24\text{hrs})$ and $< 5\% \text{RH}$, taped reel type.
2. $100 \pm 3^{\circ}\text{C} \times (45\text{min} \sim 1\text{hr})$, bulk type.
3. $130 \pm 3^{\circ}\text{C} \times (15\text{min} \sim 30\text{min})$, bulk type.

Precautions

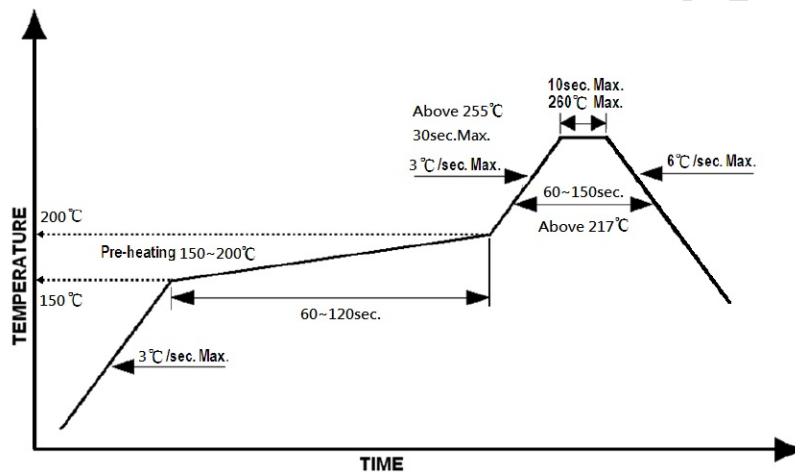
1. Avoid exposure to moisture at all times during transportation or storage.
2. Anti-Static precaution must be taken when handling GaN, InGaN, and AlInGaP products.
3. It is suggested to connect the unit with a current limiting resistor of the proper size. Avoid applying a reverse voltage beyond the specified limit.
4. Avoid operation beyond the limits as specified by the absolute maximum ratings.
5. Avoid direct contact with the surface through which the LED emits light.
6. If possible, assemble the unit in a clean room or dust-free environment.

Reflow Soldering

Recommend soldering paste specifications:

1. Operating temp.: Above 217°C ,60~150 sec.
2. Peak temp.:260°C Max.,10sec Max.
3. Reflow soldering should not be done more than two times.
4. Never attempt next process until the component is cooled down to room temperature after reflow.
5. The recommended reflow soldering profile (measured on the surface of the LED terminal) is as following:

Lead-free Solder Profile



Reworking

- Rework should be completed within 5 seconds under 260°C.
- The iron tip must not come in contact with the copper foil.
- Twin-head type is preferred.

Cleaning

Following are cleaning procedures after soldering:

- An alcohol-based solvent such as isopropyl alcohol (IPA) is recommended.
- Temperature x Time should be 50°C x 30sec. or <30°C x 3min
- Ultrasonic cleaning: < 15W/ bath; bath volume ≤ 1liter
- Curing: 100°C max, <3min